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Balanced Twisted-Pair Telecommunications Cabling and Components Standard

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TABLE OF CONTENTS

1	SCOPE 1	1
2	NORMATIVE AND INFORMATIVE REFERENCES	1
3	DEFINITIONS, ABBREVIATIONS AND ACRONYMS, UNITS OF MEASURE	4
3.1	General	4
3.2	Definitions	4
3.3	Acronyms and abbreviations	6
3.4	Units of measure	7
3.5	Variables	7
4	GENERAL	8
4.1	Backward compatibility and interoperability	8
4.2	Recognized categories	8
5	MECHANICAL REQUIREMENTS	9
5.1	Channel mechanical performance	9
5.2	Permanent link mechanical performance	9
5.3	Horizontal cable (cabling subsystem 1) mechanical performance	9
5.3.1	Insulated conductor	9
5.3.2	Pair assembly	9
5.3.3	Insulated conductor color code	9
5.3.4	Horizontal cable diameter	10
5.3.5	Horizontal cable breaking strength	10
5.3.6	Horizontal cable cold bend radius	10
5.3.7	Horizontal cable performance marking	10
5.3.8	Horizontal cable core wrap	10
5.3.9	Horizontal cable core shield (screened only)	10
5.3.10	Horizontal cable dielectric strength	11
5.4	Bundled and hybrid cable mechanical performance	11
5.5	Cord cable mechanical performance	11
5.5.1	Cord cable general	11
5.5.2	Cord cable flex life (screened only)	11
5.6	Backbone cable (cabling subsystem 2 and 3) mechanical performance	11
5.6.1	Backbone cable insulated conductor	11
5.6.2	Pair assembly	11
5.6.3	Insulated conductor color code	12
5.6.4	Core assembly	12
5.6.5	Core shield	12
5.6.6	Jacket	12
5.6.7	Performance marking	12
5.6.8	Dielectric strength	12
5.6.9	Core shield resistance	12
5.7	Connecting hardware mechanical performance	12
5.7.1	Connecting hardware environmental compatibility	12
5.7.2	Connecting hardware mounting	13
5.7.3	Connecting hardware mechanical termination density	13
5.7.4	Connecting hardware design	13
5.7.5	Work area telecommunications/equipment outlet/connector	14
5.7.6	Performance marking	15

5.7.7	Connecting hardware reliability.....	15
5.7.8	Connecting hardware shield mating interface (screened only)	15
5.7.9	Connecting hardware shield continuity (screened only).....	16
5.8	Cords and jumpers mechanical performance.....	16
5.8.1	Cords and jumpers insulated conductor	16
5.8.2	Cords and jumpers insulated conductor color codes.....	16
6	TRANSMISSION REQUIREMENTS	17
6.1	General	17
6.1.1	Return loss.....	17
6.1.2	Insertion loss.....	17
6.1.3	NEXT loss.....	17
6.1.4	PSNEXT loss	17
6.1.5	FEXT loss	17
6.1.6	ACRF	18
6.1.7	PSACRF	18
6.1.8	TCL	18
6.1.9	ELTCTL.....	19
6.1.10	Coupling attenuation.....	19
6.1.11	Propagation delay.....	19
6.1.12	Propagation delay skew.....	19
6.1.13	PSANEXT loss.....	19
6.1.14	Average PSANEXT loss	20
6.1.15	PSAFEXT loss (connecting hardware only)	20
6.1.16	PSAACRF	20
6.1.17	Average PSAACRF.....	21
6.2	Channel configurations	22
6.2.1	Category 3 through category 6A channel configuration	22
6.2.2	Category 8 channel configuration	23
6.3	Channel transmission performance.....	24
6.3.1	Category 3 through category 6A dc loop resistance.....	24
6.3.2	Category 8 channel dc loop resistance	24
6.3.3	Channel dc resistance unbalance.....	24
6.3.4	Channel dc resistance unbalance between pairs	24
6.3.5	Channel mutual capacitance	25
6.3.6	Channel capacitance unbalance: pair-to-ground.....	25
6.3.7	Channel characteristic impedance and structural return loss (SRL)	25
6.3.8	Channel return loss.....	25
6.3.9	Channel insertion loss	26
6.3.10	Channel NEXT loss.....	29
6.3.11	Channel PSNEXT loss.....	31
6.3.12	Channel FEXT loss.....	32
6.3.13	Channel ACRF	33
6.3.14	Channel PSFEXT loss	34
6.3.15	Channel PSACRF	35
6.3.16	Channel TCL.....	36
6.3.17	Channel TCTL.....	37
6.3.18	Channel ELTCTL	38
6.3.19	Category 3 through 6A channel coupling attenuation.....	39
6.3.20	Category 8 channel coupling attenuation	39
6.3.21	Channel Propagation delay	40
6.3.22	Channel propagation delay skew.....	41
6.3.23	Channel ANEXT loss	41
6.3.24	Channel PSANEXT loss	42
6.3.25	Channel Average PSANEXT loss.....	44

6.3.26	Channel AFEXT loss	45
6.3.27	Channel PSAFEXT loss.....	45
6.3.28	Channel PSAACRF.....	45
6.3.29	Channel average PSAACRF	46
6.4	Permanent link transmission performance	48
6.4.1	Category 3 through 6A permanent link dc loop resistance.....	49
6.4.2	Category 8 permanent link dc loop resistance	49
6.4.3	Category 3 through 6A permanent link dc resistance unbalance.....	49
6.4.4	Category 8 permanent link dc resistance unbalance within a pair	49
6.4.5	Category 8 permanent link dc resistance unbalance between pairs	49
6.4.6	Permanent link mutual capacitance.....	50
6.4.7	Permanent link capacitance unbalance: pair-to-ground	50
6.4.8	Permanent link characteristic impedance and structural return loss (SRL).....	50
6.4.9	Permanent link return loss	50
6.4.10	Permanent link Insertion loss.....	52
6.4.11	Permanent link NEXT loss.....	54
6.4.12	Permanent link PSNEXT loss	56
6.4.13	Permanent link FEXT loss	57
6.4.14	Permanent link ACRF	58
6.4.15	Permanent link PSFEXT loss	59
6.4.16	Permanent link PSACRF	60
6.4.17	Permanent link TCL	61
6.4.18	Permanent link TCTL.....	62
6.4.19	Permanent link ELTCTL	62
6.4.20	Permanent link coupling attenuation.....	63
6.4.21	Permanent link propagation delay	64
6.4.22	Permanent link propagation delay skew	65
6.4.23	Permanent link ANEXT loss	65
6.4.24	Permanent link PSANEXT loss.....	66
6.4.25	Permanent link average PSANEXT Loss	68
6.4.26	Permanent link AFEXT loss.....	69
6.4.27	Permanent link PSAFEXT loss	69
6.4.28	Permanent link PSAACRF.....	70
6.4.29	Permanent link average PSAACRF loss	70
6.5	Category 8 direct attach channel transmission performance	72
6.5.1	Category 8 direct attach channel return loss	72
6.5.2	Category 8 direct attach channel insertion loss.....	73
6.5.3	Category 8 direct attach channel NEXT loss.....	74
6.5.4	Category 8 direct attach channel PSNEXT loss	75
6.5.5	Category 8 direct attach channel ACRF	76
6.5.6	Category 8 direct attach channel PSACRF	78
6.5.7	Category 8 direct attach channel propagation delay	79
6.5.8	Category 8 direct attach channel propagation delay skew.....	79
6.6	Horizontal cable transmission performance	80
6.6.1	Horizontal cable dc resistance.....	80
6.6.2	Horizontal cable dc resistance unbalance	80
6.6.3	Category 8 horizontal cable dc resistance unbalance pair-to-pair	80
6.6.4	Horizontal cable Mutual capacitance	80
6.6.5	Horizontal cable Capacitance unbalance: pair-to-ground.....	81
6.6.6	Horizontal cable Characteristic impedance and structural return loss (SRL).....	81
6.6.7	Horizontal cable Return loss.....	83
6.6.8	Horizontal cable Insertion loss.....	84
6.6.9	Horizontal cable NEXT loss	86
6.6.10	Horizontal cable PSNEXT loss	87

6.6.11	Horizontal cable FEXT loss	88
6.6.12	Horizontal cable ACRF	88
6.6.13	Horizontal cable PSFEXT loss.....	89
6.6.14	Horizontal cable PSACRF	89
6.6.15	Horizontal cable TCL	90
6.6.16	Horizontal cable TCTL	91
6.6.17	Horizontal cable ELTCTL.....	91
6.6.18	Horizontal cable coupling attenuation (screened only).....	92
6.6.19	Horizontal cable Propagation delay	92
6.6.20	Category 8 horizontal cable propagation delay	93
6.6.21	Category 3 through 6A horizontal cable propagation delay skew	94
6.6.22	Category 8 horizontal cable propagation delay skew	94
6.6.23	Horizontal cable surface transfer impedance (screened only)	94
6.6.24	Horizontal cable ANEXT loss.....	95
6.6.25	Horizontal cable PSANEXT loss.....	95
6.6.26	Horizontal cable Average PSANEXT loss	96
6.6.27	Horizontal cable AFEXT loss	96
6.6.28	Horizontal cable PSAFEXT loss	96
6.6.29	Horizontal cable PSAACRF	96
6.6.30	Category 8 horizontal cable PSAACRF	97
6.6.31	Horizontal cable Average PSAACRF.....	97
6.7	Bundled and hybrid cable transmission performance.....	97
6.7.1	Bundled and hybrid cable PSNEXT loss	98
6.7.2	Bundled and hybrid cable PSNEXT loss from internal and external pairs (category 6 cables only)	98
6.8	Cord cable transmission performance	98
6.8.1	Cord cable dc resistance	98
6.8.2	Cord cable return loss.....	99
6.8.3	Category 3 through 6A cord cable insertion loss.....	100
6.8.4	Category 8 cord cable insertion loss.....	101
6.9	Backbone cable transmission performance.....	102
6.9.1	Backbone cable insertion loss	102
6.9.2	Backbone cable NEXT loss	102
6.9.3	Category 3 through 6A backbone cable PSNEXT loss	103
6.9.4	Category 3 through 6A backbone cable ACRF	105
6.9.5	Category 3 through 6A backbone cable PSACRF.....	107
6.9.6	Category 3 through 6A backbone cable propagation delay	108
6.9.7	Category 5e through 6A backbone cable propagation delay skew	108
6.10	Connecting hardware transmission performance	109
6.10.1	Connecting hardware dc resistance	109
6.10.2	Connecting hardware dc contact resistance.....	110
6.10.3	Connecting hardware dc resistance unbalance.....	110
6.10.4	Connecting hardware mutual capacitance	110
6.10.5	Connecting hardware capacitance unbalance: pair-to-ground.....	110
6.10.6	Connecting hardware characteristic impedance and structural return loss (SRL)	110
6.10.7	Connecting hardware return loss.....	110
6.10.8	Connecting hardware insertion loss.....	112
6.10.9	Connecting hardware NEXT loss.....	113
6.10.10	Connecting hardware PSNEXT loss.....	114
6.10.11	Connecting hardware FEXT loss	115
6.10.12	Connecting hardware ACRF	116
6.10.13	Connecting hardware PSFEXT loss	116
6.10.14	Connecting hardware PSACRF	116
6.10.15	Connecting hardware TCL.....	117

6.10.16	Connecting hardware TCTL.....	118
6.10.17	Connecting hardware ELTCTL	118
6.10.18	Connecting hardware coupling attenuation (screened only)	119
6.10.19	Connecting hardware propagation delay.....	119
6.10.20	Connecting hardware propagation delay skew.....	119
6.10.21	Connecting hardware shield transfer impedance (screened only)	119
6.10.22	Connecting hardware ANEXT loss	120
6.10.23	Connecting hardware PSANEXT loss	120
6.10.24	Connecting hardware Average PSANEXT loss.....	121
6.10.25	Connecting hardware AFEXT loss.....	121
6.10.26	Connecting hardware PSAFEXT loss.....	122
6.10.27	Connecting hardware PSAACRF.....	122
6.10.28	Connecting hardware Average PSAACRF	123
6.11	Cord transmission performance.....	123
6.11.1	Cord return loss	123
6.11.2	Cord NEXT loss	124
Annex A	(normative) - Reliability testing of connecting hardware	128
A.1	General	128
A.2	Modular plugs and jacks	128
A.3	Solderless connections	130
A.4	Other connecting hardware	130
A.5	Informative examples of referenced test schedules	132
A.5.1	General	132
A.5.2	Non-accessible IDC, IEC 60352-3.....	132
A.5.3	Modular plug and jack, IEC 60603-7 series.....	133
Annex B	(normative) - Measurement requirements (general)	134
B.1	General test configuration.....	134
B.2	Termination of a cable DUT to test system	134
B.2.1	Interconnections between the device under test (DUT) and the calibration plane.....	134
B.2.1.1	Test lead return loss requirements	135
B.3	Ground plane requirements	137
B.4	Network analyzer requirements	137
B.5	Measurement points and spacing.....	137
B.6	Impedance matching terminations.....	138
B.6.1	Resistor terminations	138
B.6.2	Termination return loss performance at the calibration plane	138
B.6.3	Termination TCL performance at the calibration plane	139
B.6.4	Calibration methods.....	139
B.6.4.1	Two-port calibration of the test system.....	139
B.6.4.2	One-port calibration of the test system.....	140
B.7	General calibration plane	140
B.7.1	Calibration references.....	140
B.7.1.1	50 Ω and 100 Ω calibration reference load requirements	140
B.7.1.2	Calibration reference load return loss requirement	141
B.7.2	Typical test equipment performance parameters	141
Annex C	(normative) - Cabling and component test procedures using baluns	142
C.1	Measurement test setup and apparatus	142
C.1.1	Balun terminations	142
C.1.2	Balun requirements.....	142
C.2	Testing of cabling.....	144